

## RoHS Compliant PCI Express Flash Drive

### Industrial PV16E-M280 BiCS5 Product Specifications



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## Specifications Overview:

- **PCIe Interface**
  - Compliant with PCI Express 4.0
  - Compliant with NVMe 1.4
  - Compatible with PCIe Gen4 x4 interface
- **Capacity**
  - 480, 960, 1920 GB
- **Performance<sup>1</sup>**
  - Interface burst read/write: 8 GB/sec
  - Sequential R/W: Up to 7,075/2,260 MB/sec
  - Random R/W (4K): Up to 1,019K/60K IOPS
  - Sustained seq. R/W: Up to 6,290/2,105 MB/sec
  - Sustained rand. R/W: Up to 774K/59K IOPS
  - Random R/W latency: 72/39  $\mu$ s
  - Random R/W QoS: 0.10/0.07 ms
- **Flash Management**
  - Low-Density Parity-Check (LDPC) Code
  - Global Wear Leveling
  - Flash bad-block management
  - Flash Translation Layer: Page Mapping
  - Power Failure Management
  - S.M.A.R.T.
  - TRIM
  - Hyper Cache Technology
  - SMART Read Refresh™
  - NVMe Secure Erase
- **NAND Flash Type: 3D eTLC (BiCS5)**
- **Enterprise Features**
  - AES 256-bit hardware encryption
  - Thermal Sensor
  - Thermal Throttling
  - End-to-End Data Protection
  - Sidefill
  - Heat Spreader
- **Temperature Range**
  - Operating: 0°C to 70°C
  - Storage: -40°C to 85°C
- **Supply Voltage**
  - 3.3V  $\pm$  5%
- **Power Consumption<sup>1</sup>**
  - Active mode: 12.40 W
  - Idle mode: 3.13 W
  - Inrush current: 4.7843 A
- **Connector Type**
  - 75-pin M.2 module pinout
- **Reliability**
  - MTBF: >2,000,000 hours
  - Data Retention: 10 years
  - Endurance
    - 1 DWPD
    - 480 GB: 920 TBW
    - 960 GB: 1,900 TBW
    - 1920 GB: 3,800 TBW
- **Form Factor**
  - Double-sided: M.2 2280-M
  - Dimensions: 22.00 x 80.00 x 4.28<sub>(max.)</sub>, unit: mm
  - Net weight: 10.88g  $\pm$  5%
- **RoHS Compliant**

Notes:

1. Varies from capacities. The values for performances and power consumptions presented are typical and may vary depending on flash configurations or platform settings. The term idle refers to the standby state of the device.
2. Windows 10 (version 1703) onwards supports the HMB (Host Memory Buffer) function.

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## 1. General Description

Apacer PV16E-M280 is a high-performance and high endurance NVMe SSD designed as the standard M.2 form factor utilizing 112-layer 3D TLC NAND Flash. PV16E-M280 supports PCIe Gen4 x4 interface and provides full compliance with NVMe 2.0 specifications, allowing the PCIe SSD to operate more effectively than SATA SSDs and greatly save on power consumption. PV16E-M280 delivers outstanding, stable performance up to 7,075 MB/s for sequential read and 2,260 MB/s for sequential write and ultra-low latency with optimized QoS. PV16E-M280 also presents better energy efficiency than traditional hard drives, extended endurance of 1 drive writes per day for 5 years and all the advantages of NAND Flash management technologies to ensure data integrity and highest levels of reliability, making it particularly suited for read-intensive, mixed-use workload applications.

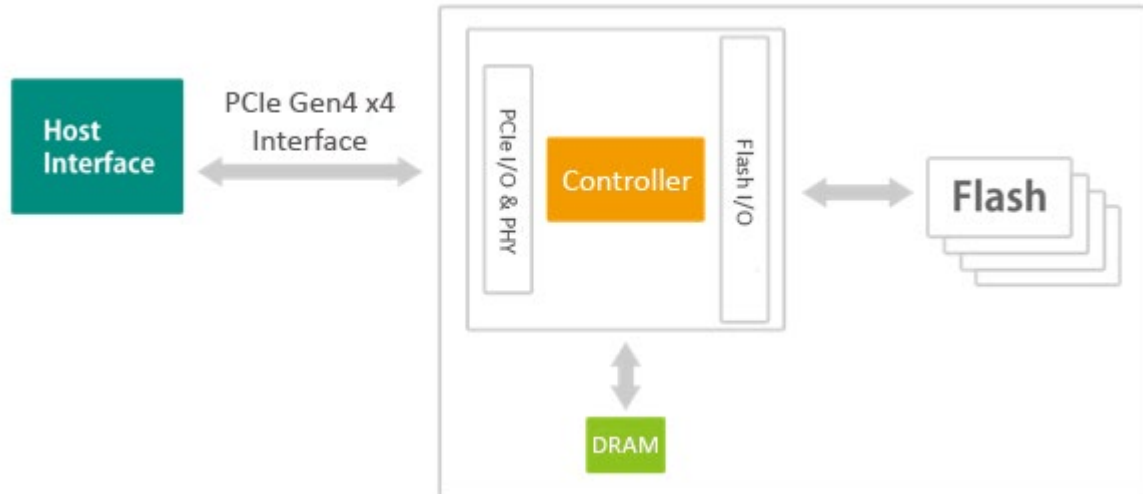
PV16E-M280 features enterprise-class reliability features implemented on both hardware and firmware levels. On the hardware level, PV16E-M280 is not only built with a powerful PCIe controller that supports on-the-module ECC as well as LDPC (Low Density Parity Check) ECC engine to extend SSD endurance and increase data reliability, but also designed with graphene heat spreader to help keep an SSD cool and functioning correctly, while still allowing the drive to deliver high-speed performance. To increase product reliability and resistance to various thermal and mechanical shocks, PV16E-M280 also provides Sidefill technology to ensure that products continue to operate normally in high vibration and under extreme environmental changes.

On the firmware level, PV16E-M280 is designed with an error-checking mechanism called End-to-End Data Protection to ensure all data in transit is protected against transient errors. To maintain consistent performance in the process of data transmission, PV16E-M280 is configured with thermal throttling technology coupled with built-in thermal sensor to monitor the temperature of the SSD via S.M.A.R.T health monitoring and dynamically adjust frequency scaling to enhance data reliability and provide sustained performance while overheating.

In addition to data reliability, PV16E-M280 also incorporates a variety of cutting-edge technologies featuring multiple approaches to data protection and security. PV16E-M280 provides exceptional performance by offloading computational tasks to a dedicated processor with AES 256-bit hardware encryption, and with the hardware-based technology, PV16E-M280 offers data security to safeguard the drive against unauthorized access at all times. To add an additional level of protection, PV16E-M280 supports SMART Read Refresh, developed particularly for read-intensive applications, to avoid read disturb errors from occurring to ensure health status of all blocks of NAND flash.

Apacer PV16E-M280 is an enterprise-class SSD designed for server applications that require consistent performance, low latency and continuous large file transfers for 24/7 uptime and reliability. With superior performance, instant responsiveness, advanced power loss protection technology and highest standard of reliability – whether in terms of data security, data integrity and data protection, Apacer PV16E-M280 is an ideal solution for enterprise servers, data centers and cloud service providers.

## 2. Functional Block



Note: The actual number of NAND flash used on Apacer PV16E-M280 varies from capacities. The illustration is for reference only.

Figure 2-1 Functional Block Diagram

### 3. Pin Assignments

This connector does not support hot plug capability. There are a total of 75 pins. 12 pin locations are used for mechanical key locations; this allows such a module to plug into Key M connectors.

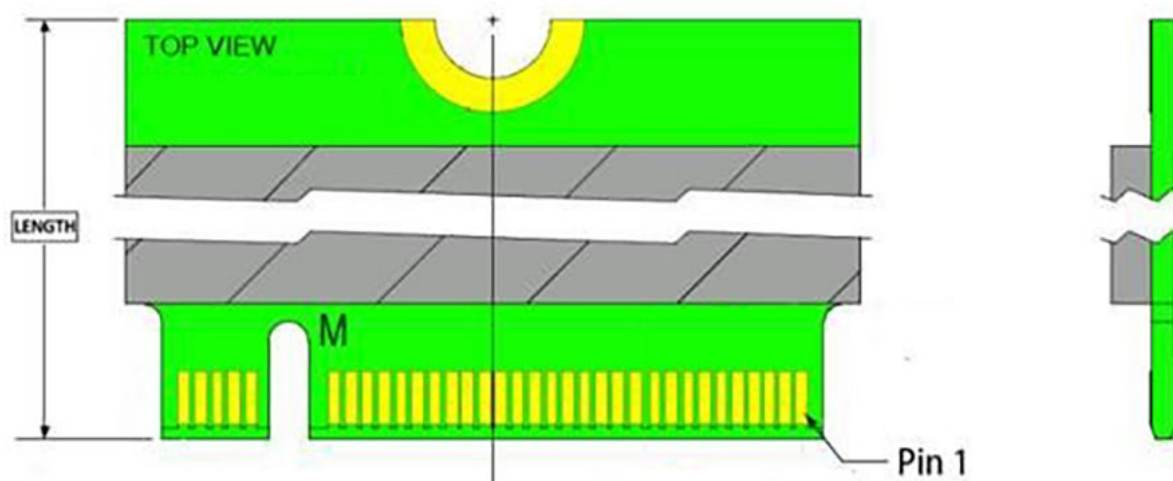


Figure 3-1 Pin Connectors

Table 3-1 Pin Assignments

Pin No.	Type	Description
1	GND	CONFIG_3 = GND
2	3.3 V	3.3V source
3	GND	Ground
4	3.3 V	3.3V source
5	PETn3	PCIe TX Differential signal defined by the PCI Express M.2 spec
6	N/C	No connect
7	PETp3	PCIe TX Differential signal defined by the PCI Express M.2 spec
8	PLN# (I)(0/3.3V)	Power Loss Notification Open drain with a pull up on Adapters.
9	GND	Ground
10	LED1#	Open drain, active low signal. These signals are used to allow the add-in card to provide status indicators via LED devices that will be provided by the system.
11	PERn3	PCIe RX Differential signal defined by the PCI Express M.2 spec
12	3.3 V	3.3V source
13	PERp3	PCIe RX Differential signals defined by the PCI Express M.2 spec
14	3.3 V	3.3V source
15	GND	Ground
16	3.3 V	3.3V source
17	PETn2	PCIe TX Differential signal defined by the PCI Express M.2 spec
18	3.3 V	3.3V source
19	PETp2	PCIe TX Differential signal defined by the PCI Express M.2 spec

**Table 3-1 Pin Assignments**

Pin No.	Type	Description
20	N/C	No connect
21	GND	Ground
22	N/C	No connect
23	PERn2	PCIe RX Differential signal defined by the PCI Express M.2 spec
24	N/C	No connect
25	PERp2	PCIe RX Differential signal defined by the PCI Express M.2 spec
26	N/C	No connect
27	GND	Ground
28	N/C	No connect
29	PETn1	PCIe TX Differential signal defined by the PCI Express M.2 spec
30	PLA_S3# (O)(0/3.3V)	Power Loss Acknowledge; Open drain with a pull up on Adapters.
31	PETp1	PCIe TX Differential signal defined by the PCI Express M.2 spec
32	GND	Ground
33	GND	Ground
34	N/C	No connect
35	PERn1	PCIe RX Differential signal defined by the PCI Express M.2 spec
36	N/C	No connect
37	PERp1	PCIe RX Differential signal defined by the PCI Express M.2 spec
38	GND	Ground
39	GND	Ground
40	SMB_CLK (I/O)(0/1.8V)	SMBus Clock; Open Drain with pull up on platform
41	PETn0	PCIe TX Differential signal defined by the PCI Express M.2 spec
42	SMB_DATA (I/O)(0/1.8V)	SMBus Data; Open Drain with pull up on platform
43	PETp0	PCIe TX Differential signal defined by the PCI Express M.2 spec
44	ALERT# (O)(0/1.8V)	Alert notification to master; Open Drain with pull up on platform; Active low.
45	GND	Ground
46	N/C	No connect
47	PERn0	PCIe RX Differential signal defined by the PCI Express M.2 spec
48	N/C	No connect
49	PERp0	PCIe RX Differential signal defined by the PCI Express M.2 spec
50	PERST# (I)(0/3.3V)	PEReset is a functional reset to the card as defined by the PCIe Mini CEM specification.
51	GND	Ground
52	CLKREQ# (I/O)(0/3.3V)	Clock Request is a reference clock request signal as defined by the PCIe Mini CEM specification; Also used by L1 PM Substates.
53	REFCLKn	PCIe Reference Clock signals (100 MHz) defined by the PCI Express M.2 spec.
54	N/C	No connect
55	REFCLKp	PCIe Reference Clock signals (100 MHz) defined by the PCI Express M.2 spec.
56	Reserved for MFG_DATA	Manufacturing Data line. Used for SSD manufacturing only. Not used in normal operation. Pins should be left N/C in platform Socket.
57	GND	Ground

**Table 3-1 Pin Assignments**

Pin No.	Type	Description
58	Reserved for MFG_CLOCK	Manufacturing Clock line. Used for SSD manufacturing only. Not used in normal operation. Pins should be left N/C in platform Socket.
59	Module Key M	Module Key
60	Module Key M	Module Key
61	Module Key M	Module Key
62	Module Key M	Module Key
63	Module Key M	Module Key
64	Module Key M	Module Key
65	Module Key M	Module Key
66	Module Key M	Module Key
67	N/C	No connect
68	N/C	No connect
69	N/C	PEDET (NC PCIe)
70	3.3V	3.3V source
71	GND	Ground
72	3.3V	3.3V source
73	GND	Ground
74	3.3V	3.3V source
75	GND	Ground

## 4. Product Specifications

### 4.1 Capacity

Capacity specifications of PV16E-M280 are available as shown in Table 4-1.

**Table 4-1 Capacity Specifications**

Capacity	Total bytes	Total LBA
480 GB	480,103,981,056	937,703,088
960 GB	960,197,124,096	1,875,385,008
1920 GB	1,920,383,410,176	3,750,748,848

Notes:

- Display of total bytes varies from operating systems.
- 1 GB = 1,000,000,000 bytes; 1 sector = 512 bytes.
- LBA count addressed in the table above indicates total user storage capacity and will remain the same throughout the lifespan of the device. However, the total usable capacity of the SSD is most likely to be less than the total physical capacity because a small portion of the capacity is reserved for device maintenance usages.

### 4.2 Performance

Performance of PV16E-M280 is listed below in Table 4-2 and 4-3.

**Table 4-2 Performance**

Performance	Unit	480 GB	960 GB	1920 GB
Sequential Read	MB/s	6,520	6,910	7,075
Sequential Write		770	1,555	2,260
4K Random Read	IOPS	497,000	1,019,000	963,000
4K Random Write		28,000	52,000	60,000

Notes:

- Results may differ from various flash configurations or host system setting.
- Sequential read/write is based on CrystalDiskMark 8.0.4 with file size 1,000MB.
- Random read/write is measured using IOMeter with Queue Depth 32.

**Table 4-3 Sustained Performance**

Performance	Unit	480 GB	960 GB	1920 GB
Sequential Read	MB/s	6,485	6,290	5,765
Sequential Write		725	1,470	2,105
4K Random Read	IOPS	371,000	568,000	774,000
4K Random Write		28,000	52,000	59,000

Notes:

- Sustained sequential read/write is measured by using FIO with 128KB and 1024KB of data transfer size in Queue Depth 32 by 1 worker.
- Sustained random read/write is measured by using FIO with 4KB of data transfer size in Queue Depth 32 by 16 worker.

### 4.3 Latency

Table 4-4 Latency

Performance	Unit	480 GB	960 GB	1920 GB
Random Read	μs	72	72	72
Random Write		39	30	30

Note: Latency is measured by using the SNIA SSS (Solid State Storage) PTS (Performance Test Specification) with 4KB data transfer size in Queue Depth 1 by 1 worker.

### 4.4 Quality of Service (QoS)

Table 4-5 Quality of Service (QoS)

Quality of Service (99.9%)	Unit	480 GB	960 GB	1920 GB
Random Read	ms	0.10	0.10	0.10
Random Write		0.06	0.07	0.06

Notes:

- QoS is measured by using StorScore with Queue Depth 1 on 4KB random read and write.
- QoS is measured as the round-trip time taken for 99.9% of commands to host.

### 4.5 Environmental Specifications

Environmental specifications of PV16E-M280 product are shown in Table 4-6.

Table 4-6 Environmental Specifications

Parameter	Type	Specifications
Temperature	Operating	0°C to 70°C
	Non-operating	-40°C to 85°C
Vibration	Operating	7.69 GRMS, 20~2000 Hz/random (compliant with MIL-STD-810G)
	Non-operating	4.02 GRMS, 15~2000 Hz/random (compliant with MIL-STD-810G)
Shock	Operating	Acceleration, 50(G)/11(ms)/half sine (compliant with MIL-STD-202G)
	Non-operating	Acceleration, 1500(G)/0.5(ms)/half sine (compliant with MIL-STD-883K)

Note: This Environmental Specification table indicates the conditions for testing the device. Real world usages may affect the results.

### 4.6 Mean Time Between Failures (MTBF)

Mean Time Between Failures (MTBF) is predicted based on reliability data for the individual components in PV16E-M280. The prediction result for PV16E-M280 is more than 2,000,000 hours.

Note: The MTBF is predicated and calculated based on “Telcordia Technologies Special Report, SR-332, Issue 3” method.

## 4.7 Certification and Compliance

PV16E-M280 complies with the following standards:

- CE
- UKCA
- FCC
- RoHS Recast
- MIL-STD-810G

## 4.8 Endurance

The endurance of a storage device is predicted by TeraBytes Written and Drive Writes Per Day based on several factors related to usage, such as the amount of data written into the drive, block management conditions, and daily workload for the drive. Thus, key factors, such as Write Amplifications and the number of P/E cycles, can influence the lifespan of the drive.

**Table 4-7 Endurance Specifications**

Capacity	TeraBytes Written	Drive Writes Per Day
480 GB	920	1
960 GB	1,900	1
1920 GB	3,800	1

Notes:

- This estimation complies with JEDEC JESD-219, Enterprise endurance workload of random data with payload size distribution.
- Flash vendor guaranteed 3D NAND TLC P/E cycle: 3K
- WAF may vary from capacity, flash configurations and writing behavior on each platform.
- 1 Terabyte = 1,024GB
- DWPD (Drive Writes Per Day) is calculated based on the number of times that user overwrites the entire capacity of an SSD per day of its lifetime during the warranty period.
- Depending on whichever occurs first, Apacer guarantees a warranty of 5 years or Terabytes Written.

## 4.9 Data Retention

**Table 4-8 Data Retention**

NAND Flash P/E Cycle	Value
100	10 years

Note: Data retention was evaluated at the temperature of 40°C.

## 5. Flash Management

### 5.1 Error Correction/Detection

PV16E-M280 implements a hardware ECC scheme, based on the Low Density Parity Check (LDPC). LDPC is a class of linear block error correcting code which has apparent coding gain over BCH code because LDPC code includes both hard decoding and soft decoding algorithms. With the error rate decreasing, LDPC can extend SSD endurance and increase data reliability while reading raw data inside a flash chip.

### 5.2 Bad Block Management

Current production technology is unable to guarantee total reliability of NAND flash memory array. When a flash memory device leaves factory, it comes with a minimal number of initial bad blocks during production or out-of-factory as there is no currently known technology that produce flash chips free of bad blocks. In addition, bad blocks may develop during program/erase cycles. Since bad blocks are inevitable, the solution is to keep them in control. Apacer flash devices are programmed with ECC, page mapping technique and S.M.A.R.T to reduce invalidity or error. Once bad blocks are detected, data in those blocks will be transferred to free blocks and error will be corrected by designated algorithms.

### 5.3 Global Wear Leveling

Flash memory devices differ from Hard Disk Drives (HDDs) in terms of how blocks are utilized. For HDDs, when a change is made to stored data, like erase or update, the controller mechanism on HDDs will perform overwrites on blocks. Unlike HDDs, flash blocks cannot be overwritten and each P/E cycle wears down the lifespan of blocks gradually. Repeatedly program/erase cycles performed on the same memory cells will eventually cause some blocks to age faster than others. This would bring flash storages to their end of service term sooner. Global wear leveling is an important mechanism that levels out the wearing of all blocks so that the wearing-down of all blocks can be almost evenly distributed. This will increase the lifespan of SSDs.

### 5.4 Power Failure Management

Power Failure Management plays a crucial role when power supply becomes unstable. Power disruption may occur when users are storing data into the SSD, leading to instability in the drive. However, with Power Failure Management, a firmware protection mechanism will be activated to scan pages and blocks once power is resumed. Valid data will be transferred to new blocks for merging and the mapping table will be rebuilt. Therefore, data reliability can be reinforced, preventing damage to data stored in the NAND Flash.

Note: The controller unit of this product model is designed with a DRAM as a write cache for improved performance and data efficiency. Though unlikely to happen in most cases, the data cached in the volatile DRAM might be potentially affected if a sudden power loss takes place before the cached data is flushed into non-volatile NAND flash memory.

## 5.5 TRIM

TRIM is a feature which helps improve the read/write performance and speed of solid-state drives (SSD). Unlike hard disk drives (HDD), SSDs are not able to overwrite existing data, so the available space gradually becomes smaller with each use. With the TRIM command, the operating system can inform the SSD which blocks of data are no longer in use and can be removed permanently. Thus, the SSD will perform the erase action, which prevents unused data from occupying blocks all the time.

## 5.6 Flash Translation Layer – Page Mapping

Page mapping is an advanced flash management technology whose essence lies in the ability to gather data, distribute the data into flash pages automatically, and then schedule the data to be evenly written. Page-level mapping uses one page as the unit of mapping. The most important characteristic is that each logical page can be mapped to any physical page on the flash memory device. This mapping algorithm allows different sizes of data to be written to a block as if the data is written to a data pool and it does not need to take extra operations to process a write command. Thus, page mapping is adopted to increase random access speed and improve SSD lifespan, reduce block erase frequency, and achieve optimized performance and lifespan.

## 5.7 Hyper Cache Technology

Apacer proprietary Hyper Cache technology uses a portion of the available capacity as SLC (1bit-per-cell) NAND flash memory, called Hyper cache mode. When data is written to SSD, the firmware will direct the data to Hyper Cache mode, providing excellent performance to handle various scenarios in industrial use.

## 5.8 SMART Read Refresh™

Apacer's SMART Read Refresh plays a proactive role in avoiding read disturb errors from occurring to ensure health status of all blocks of NAND flash. Developed for read-intensive applications in particular, SMART Read Refresh is employed to make sure that during read operations, when the read operation threshold is reached, the data is refreshed by re-writing it to a different block for subsequent use.

## 5.9 NVMe Secure Erase

NVMe Secure Erase is an NVMe drive sanitize command currently embedded in most of the storage drives. Defined in NVMe specifications, NVMe Secure Erase is part of Format NVM command that allows storage drives to erase all user data areas. The erase process usually runs on the firmware level as most of the NVMe-based storage media currently in the market are built-in with this command. NVMe Secure Erase can securely wipe out the user data in the drive and protects it from malicious attack.

## 6. Reliability Features

### 6.1 Advanced Encryption Standard

Advanced Encryption Standard (AES) is a specification for the encryption of electronic data. AES has been adopted by the U.S. government since 2001 to protect classified information and is now widely implemented in embedded computing applications. The AES algorithm used in software and hardware is symmetric so that encrypting/decrypting requires the same encryption key. Without the key, the encrypted data is inaccessible to ensure information security.

Notably in flash memory applications, AES 256-bit hardware encryption is the mainstream to protect sensitive or confidential data. The hardware encryption provides better performance, reliability, and security than software encryption. It uses a dedicated processor, which is built inside the controller, to process the encryption and decryption. This enormously shortens the processing time and makes it efficient.

### 6.2 Thermal Sensor

Apacer Thermal Sensor is a digital temperature sensor with serial interface. By using a designated pin for transmission, storage device owners are able to read temperature data.

### 6.3 Thermal Throttling

Thermal throttling can monitor the temperature of the SSD equipped with a built-in thermal sensor via S.M.A.R.T. commands. This method can ensure the temperature of the device stays within temperature limits by drive throttling, i.e. reducing the speed of the drive when the device temperature reaches the threshold level, so as to prevent overheating, guarantee data reliability, and prolong product lifespan. When the temperature exceeds the maximum threshold level, thermal throttling will be triggered to reduce performance step by step to prevent hardware components from being damaged. Performance is only permitted to drop to the extent necessary for recovering a stable temperature to cool down the device's temperature. Once the temperature decreases to the minimum threshold value, transfer speeds will rise back to its optimum performance level.

### 6.4 End-to-End Data Protection

End-to-End Data Protection is a feature implemented in Apacer SSD products that extends error control to cover the entire path from the host computer to the drive and back, and ensure data integrity at multiple points in the path to enable reliable delivery of data transfers. Unlike ECC which does not exhibit the ability to determine the occurrence of errors throughout the process of data transmission, End-to-End Data Protection allows SSD controller to identify an error created anywhere in the path and report the error to the host computer before it is written to the drive. This error-checking and error-reporting mechanism therefore guarantees the trustworthiness and reliability of the SSD.

### 6.5 Sidefill

Apacer's Sidefill technology strengthens the connections between solder joints and their board, making them more robust and vibration-resistant. It also allows for heat dissipation to offset thermal damage.

## 6.6 Heat Spreader

In many applications, SSDs are subject to challenging conditions. If the working environment is already hot, and the SSD's operation causes it to increase in temperature as well, the result could be damage to the hardware or corrupted data. For this reason, Apacer's graphene heat spreader is developed for heat dissipation to cool both the NAND Flash and the Controller IC, while still allowing an SSD to deliver high-speed performance, as well as prevent heat-related damage from occurring.

## 7. Software Interface

### 7.1 Command Set

Table 7-1 summarizes the commands supported by PV16E-M280.

**Table 7-1 Admin Commands**

Opcode	Command Description
00h	Delete I/O Submission Queue
01h	Create I/O Submission Queue
02h	Get Log Page
04h	Delete I/O Completion Queue
05h	Create I/O Completion Queue
06h	Identify
08h	Abort
09h	Set Features
0Ah	Get Features
0Ch	Asynchronous Event Request
10h	Firmware Activate
11h	Firmware Image Download
14h	Device Self-test

**Table 7-2 Admin Commands – NVM Command Set Specific**

Opcode	Command Description
80h	Format NVM
81h	Security Send
82h	Security Receive
84h	Sanitize

**Table 7-3 NVM Commands**

Opcode	Command Description
00h	Flush
01h	Write
02h	Read
04h	Write Uncorrectable
05h	Compare
08h	Write Zeroes
09h	Dataset Management

## 7.2 S.M.A.R.T.

SMART, an acronym for Self-Monitoring, Analysis and Reporting Technology, is an open standard that allows a hard disk drive to automatically detect its health and report potential failures. When a failure is recorded by SMART, users can choose to replace the drive to prevent unexpected outage or data loss. Moreover, SMART can inform users of impending failures while there is still time to perform proactive actions, such as copy data to another device.

**Table 7-4 SMART (02h)**

Byte	Length	Description
0	1	Critical Warning
1-2	2	Composite Temperature (NAND Flash Temperature)
3	1	Available Spare
4	1	Available Spare Threshold
5	1	Percentage Used (Average Erase Count / P/E Cycle Count)
6-31	26	Reserved
32-47	16	Data Units Read
48-63	16	Data Units Written
64-79	16	Host Read Commands
80-95	16	Host Write Commands
96-111	16	Controller Busy Time
112-127	16	Power Cycles
128-143	16	Power On Hours
144-159	16	Unsafe Shutdowns
160-175	16	Media and Data Integrity Errors
176-191	16	Number of Error Information Log Entries
192-195	4	Warning Composite Temperature Time
196-199	4	Critical Composite Temperature Time
200-201	2	Temperature Sensor 1
202-203	2	Temperature Sensor 2:
204-205	2	Temperature Sensor 3
206-207	2	Temperature Sensor 4
208-209	2	Temperature Sensor 5
210-211	2	Temperature Sensor 6
212-213	2	Temperature Sensor 7
214-215	2	Temperature Sensor 8
216-511	296	Reserved

Note: Temperature display of the Temperature Sensor from 1 to 8 (corresponding bytes from 200 to 215) is not supported if the return value is 0h.

## 8. Electrical Specifications

### 8.1 Operating Voltage

Table 8-1 lists the supply voltage for PV16E-M280.

Table 8-1 Operating Range

Item	Range
Supply Voltage	3.3V $\pm$ 5%

### 8.2 Power Consumption

Table 8-2 lists the power consumption for PV16E-M280.

Table 8-2 Power Consumption

Mode	Unit	480 GB	960 GB	1920 GB
Read	W	8.96	10.64	12.40
Write		5.33	7.95	10.35
Idle		2.99	3.09	3.13

Notes:

- All values are typical and may vary depending on flash configurations or host system settings.
- Power consumption is measured using CrystalDiskMark 8.0.4 with file size 1,000MB.

### 8.3 Inrush Current

Table 8-3 Inrush Current

Inrush Current	480 GB	960 GB	1920 GB
3.3V	4.7843		

## 9. Mechanical Specifications

Table 9-1 Physical Information

Parameter	Unit	480 GB	960 GB	1920 GB
Length	mm	80.00 ± 0.15		
Width		22.00 ± 0.15		
Height (Max.)		4.28		
Weight	g ± 5%	9.88	10.55	10.88

### Top view

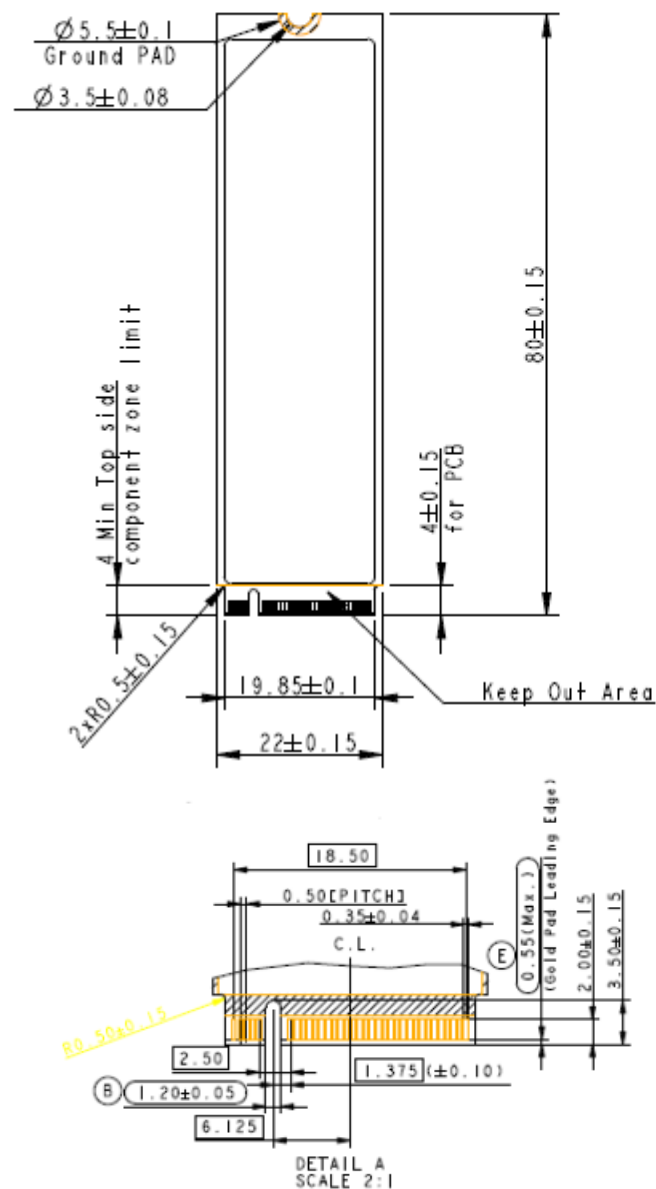


Figure 9-1 Dimensions – Top View

Side view

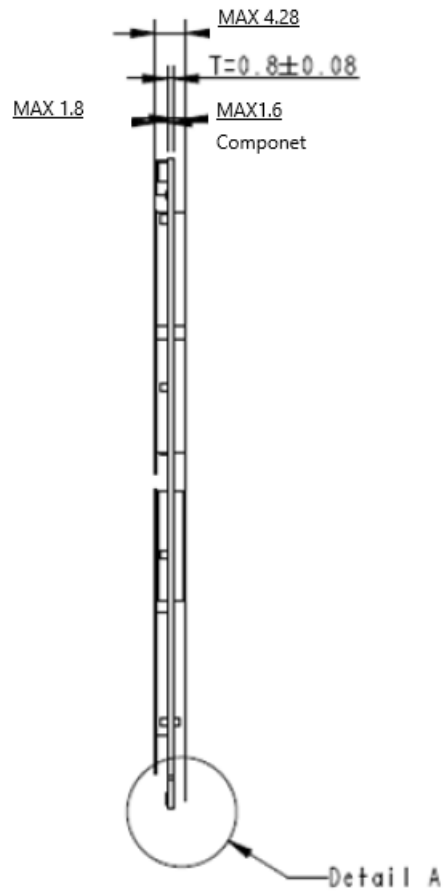


Figure 9-2 Dimensions – Side View

Bottom view

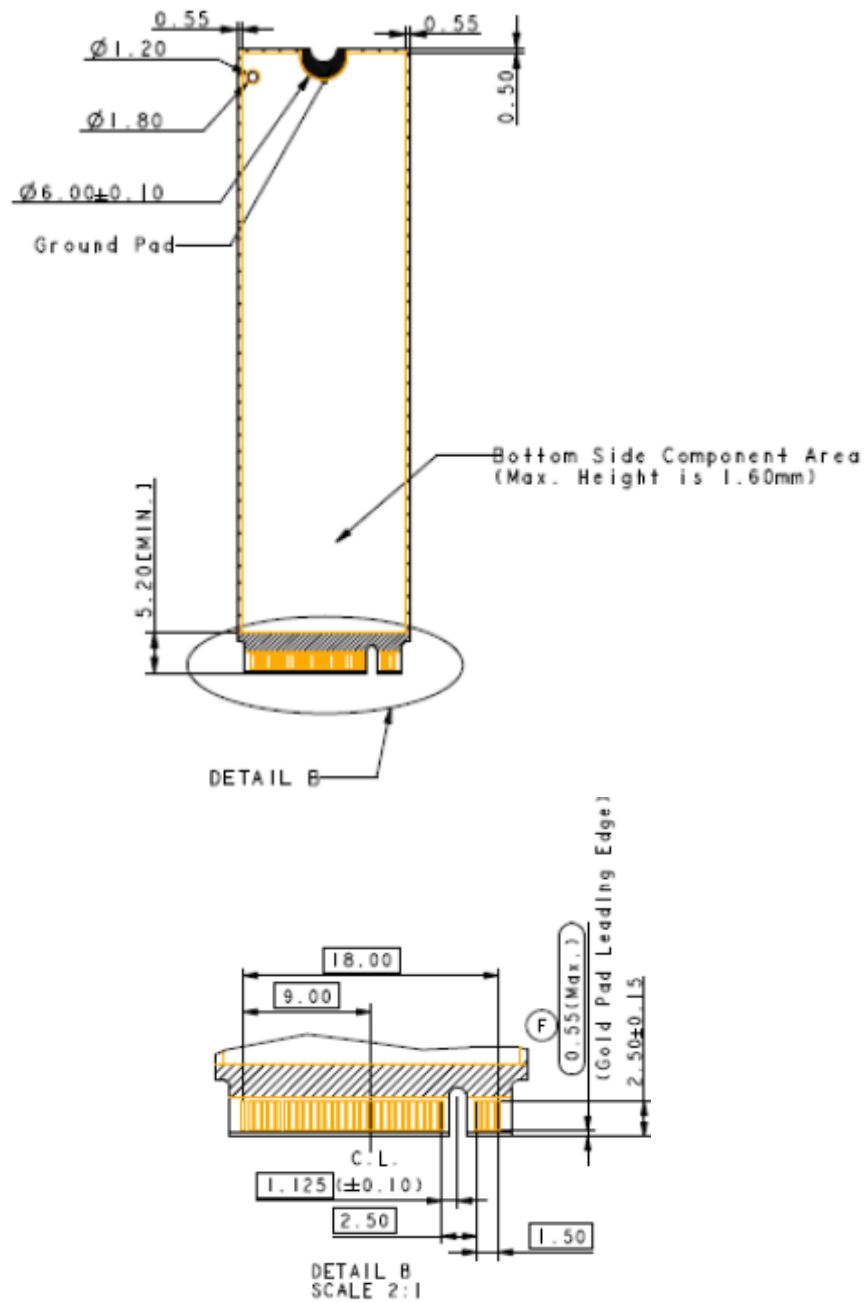


Figure 9-3 Dimensions – Bottom View

## 10. Product Ordering Information

### 10.1 Product Code Designations

Apacer's PV16E-M280 SSD is available in different configurations and densities. See the chart below for a comprehensive list of options for the PV16E-M280 series devices.

Code	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
	B	9	6	.	P	4	5	X	G	U	.	0	0	1	E	1

<b>Code 1-3 (Product Line &amp; Form Factor)</b>	PCIe M.2 2280
<b>Code 5-6 (Model/Solution)</b>	PV16E-M280
<b>Code 7-8 (Product Capacity)</b>	5K: 480GB 5L: 960GB 5M: 1920GB
<b>Code 9 (Flash Type &amp; Product Temp)</b>	3D TLC standard temperature
<b>Code 10 (Product Spec)</b>	Double-sided M key with graphene
<b>Code 12-14 (Version Number)</b>	Random numbers generated by system
<b>Code 15-16 (Firmware Version)</b>	Thermal Sensor OP

## 10.2 Valid Combinations

The following table lists the available models of the PV16E-M280 series which are in mass production or will be in mass production. Consult your Apacer sales representative to confirm availability of valid combinations and to determine availability of new combinations.

Capacity	Valid Combination
480GB	B96.P45KGU.001E1
960GB	B96.P45LGU.001E1
1920GB	B96.P45MGU.001E1

## Revision History

Revision	Description	Date
1.0	Initial release	11/7/2023

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